### Edgar Filing: ADVANCED SEMICONDUCTOR ENGINEERING INC - Form 6-K

ADVANCED SEMICONDUCTOR ENGINEERING INC Form 6-K May 05, 2005

# FORM 6-K SECURITIES AND EXCHANGE COMMISSION

Washington, D.C. 20549

**Report of Foreign Private Issuer** 

Pursuant to Rule 13a-16 or 15d-16 of the Securities Exchange Act of 1934

May 5, 2005

Commission File Number 001-16125

## Advanced Semiconductor Engineering, Inc.

(Exact name of Registrant as specified in its charter)

26 Chin Third Road Nantze Export Processing Zone Kaoshiung, Taiwan Republic of China (Address of principal executive offices)

Indicate by check mark whether the registrant files or will file annual reports under cover of Form 20-F or Form 40-F.

Form 20-F X Indicate by check mark if the registrant permitted by Regulation S-T Rule 101(1)	
<b>Note:</b> Regulation S-T Rule 101(b)(1) or Form 6-K if submitted solely to provide holders.	nly permits the submission in paper of a an attached annual report to security
Indicate by check mark if the registrant permitted by Regulation S-T Rule 1010	

**Note:** Regulation S-T Rule 101(b)(7) only permits the submission in paper of a Form 6-K if submitted to furnish a report or other document that the registrant foreign private issuer must furnish and make public under the laws of the jurisdiction in which the registrant is incorporated, domiciled or legally organized (the registrant s home country), or under the rules of the home country exchange on which the registrant s securities are traded, as long as the report or other document is not a press release, is not required to be and has not been distributed to the registrant s security holders, and, if discussing a material event, has already been the subject of a Form 6-K submission or other Commission filing on EDGAR.

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	Indicate by check mark whe Form, the registrant is also to pursuant to Rule 12g3-2(b) to	hereby furnishing the info	ormation to the Commission	
	Yes If Yes is marked, indicate connection with Rule 12g3-2 Not applicable		No X ssigned to the registrant in	
Pursuant to the requireme	nts of the Securities Exchange A	Signatures	has duly caused this report to be	e signed on its behalf by the
undersigned, thereunto du		ect of 1931, the registration	has dary caused this report to be	e signed on its benan by the
			ED SEMICONDUCTOR ERING, INC.	
	Date: May 5, 2005	Ву:	/s/ Joseph Tung	
			Joseph Tung Chief Financial Officer	
				ITEM 1

# **Advanced Semiconductor Engineering, Inc.**

#### FOR IMMEDIATE RELEASE

**Contact:** 

ASE, Inc.

**Freddie Liu**, Financial Controller ir@aseglobal.com

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ADVANCED SEMICONDUCTOR ENGINEERING, INC. PRESS RELEASE

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TAIPEI, TAIWAN, R.O.C., MAY 2, 2005 Advanced Semiconductor Engineering Inc. (TAIEX: 2311, NYSE: ASX) ([We], [ASE], or the [Company]) today provided additional information relating to the fire that took place yesterday at its facilities in Chungli, Taiwan. Beginning this morning, local governmental authorities have initiated investigations into the cause of the fire. While the official investigations continue, the Company has commenced discussions with insurance providers relating to claims for the damage caused by the fire. Representatives from insurance providers visited the premises today to conduct an inspection of the damage caused by the fire.

ASE has retained structural engineers to assess the extent of the damage to the building that caught fire. The first four floors of the building, which housed part of the Company soperations for the production of interconnect materials, suffered direct damage by the fire. The Company estimates the damage to equipment and inventory on these floors, most of which is covered by insurance, at US\$130 million. This does not include any damage to the building which has been incurred. In addition, most of the equipment and inventory on other floors of the eleven-floor building, the substantial majority of which is for semiconductor packaging and test, while not damaged by the fire, were damaged by smoke caused by the fire. The Company expects to commence, with the insurance providers, the process of assessing the actual extent of damage, upon regaining access to all floors of the building. The Company will also begin its clean-up efforts tomorrow.

The Company currently estimates that its production facilities in Kaohsiung have sufficient packaging and test capacity to meet all customer requirements that are expected to be diverted from Chungli as a result of the fire. Following direct communications with its customers, ASE expects to facilitate expeditiously their qualification of ASE\[ \] Kaohsiung facilities in order to give effect to the planned transfer of production as quickly and smoothly as possible, pending the recovery of Chungli to full operating capacity.